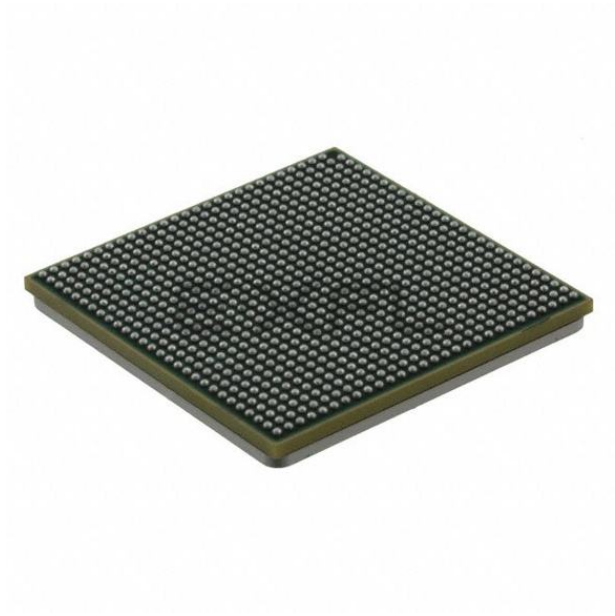

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Understanding Embedded - DSP (Digital Signal Processors)

Embedded - DSP (Digital Signal Processors) are specialized microprocessors designed to perform complex mathematical computations on digital signals in real-time. Unlike general-purpose processors, DSPs are optimized for high-speed numeric processing tasks, making them ideal for applications that require efficient and precise manipulation of digital data. These processors are fundamental in converting and processing signals in various forms, including audio, video, and communication signals, ensuring that data is accurately interpreted and utilized in embedded systems.

Applications of Embedded - DSP (Digital Signal Processors)

Details	
Product Status	Obsolete
Type	SC3850 Six Core
Interface	Ethernet, I²C, PCI, RGMII, Serial RapidIO, SGMII, SPI, UART/USART
Clock Rate	1GHz
Non-Volatile Memory	ROM (96kB)
On-Chip RAM	576kB
Voltage - I/O	2.50V
Voltage - Core	1.00V
Operating Temperature	0°C ~ 105°C (TJ)
Mounting Type	Surface Mount
Package / Case	783-BBGA, FCBGA
Supplier Device Package	783-FCPBGA (29x29)
Purchase URL	https://www.e-xfl.com/pro/item?MUrl=&PartUrl=msc8156svt1000b

2.2 Recommended Operating Conditions

Table 3 lists recommended operating conditions. Proper device operation outside of these conditions is not guaranteed.

Table 3. Recommended Operating Conditions

Rating	Symbol	Min	Nominal	Max	Unit
Core supply voltage	V_{DD}	0.97	1.0	1.05	V
M3 memory supply voltage	V_{DDM3}	0.97	1.0	1.05	V
MAPLE-B supply voltage	V_{DDM}	0.97	1.0	1.05	V
DDR memory supply voltage • DDR2 mode • DDR3 mode DDR reference voltage	V_{DDDDR} MV_{REF}	 1.7 1.425 $0.49 \times V_{DDDDR}$	 1.8 1.5 $0.5 \times V_{DDDDR}$	 1.9 1.575 $0.51 \times V_{DDDDR}$	 V V V
I/O voltage excluding DDR and RapidIO lines	V_{DDIO}	2.375	2.5	2.625	V
Rapid I/O pad voltage	V_{DDSXP}	0.97	1.0	1.05	V
Rapid I/O core voltage	V_{DDSXC}	0.97	1.0	1.05	V
Operating temperature range: • Standard • Higher • Extended	 T_J T_J T_A T_J	 0 0 –40 —		 90 105 — 105	 °C °C °C

2 Electrical Characteristics

This document contains detailed information on power considerations, DC/AC electrical characteristics, and AC timing specifications. For additional information, see the *MSC8156 Reference Manual*.

2.1 Maximum Ratings

In calculating timing requirements, adding a maximum value of one specification to a minimum value of another specification does not yield a reasonable sum. A maximum specification is calculated using a worst case variation of process parameter values in one direction. The minimum specification is calculated using the worst case for the same parameters in the opposite direction. Therefore, a "maximum" value for a specification never occurs in the same device with a "minimum" value for another specification; adding a maximum to a minimum represents a condition that can never exist.

Table 2 describes the maximum electrical ratings for the MSC8156.

Table 2. Absolute Maximum Ratings

Rating	Power Rail Name	Symbol	Value	Unit
Core supply voltage • Cores 0–5	VDD	V_{DD}	–0.3 to 1.1	V
PLL supply voltage[3]		V_{DDPLL0} V_{DDPLL1} V_{DDPLL2}	–0.3 to 1.1 –0.3 to 1.1 –0.3 to 1.1	V V V
M3 memory supply voltage	M3VDD	V_{DDM3}	–0.3 to 1.1	V
MAPLE-B supply voltage	MVDD	V_{DDM}	–0.3 to 1.1	V
DDR memory supply voltage • DDR2 mode • DDR3 mode	GVDD1, GVDD2	V_{DDDDR}	 –0.3 to 1.98 –0.3 to 1.65	 V V
DDR reference voltage	MVREF	MV_{REF}	–0.3 to 0.51 × V_{DDDDR}	V
Input DDR voltage		V_{INDDR}	–0.3 to V_{DDDDR} + 0.3	V
I/O voltage excluding DDR and RapidIO lines	NVDD, QVDD	V_{DDIO}	–0.3 to 2.625	V
Input I/O voltage		V_{INIO}	–0.3 to V_{DDIO} + 0.3	V
RapidIO pad voltage	SXPVDD1, SXPVDD2	V_{DDSXP}	–0.3 to 1.26	V
Rapid I/O core voltage	SXCVDD1, SXCVDD2	V_{DDSXC}	–0.3 to 1.21	V
Rapid I/O PLL voltage[3]		$V_{DDRIOPLL}$	–0.3 to 1.21	V
Input RapidIO I/O voltage		V_{INRIO}	–0.3 to V_{DDSXC} + 0.3	V
Operating temperature		T_J	–40 to 105	°C
Storage temperature range		T_{STG}	–55 to +150	°C

Notes:
1. Functional operating conditions are given in Table 3.
2. Absolute maximum ratings are stress ratings only, and functional operation at the maximum is not guaranteed. Stress beyond the listed limits may affect device reliability or cause permanent damage.
3. PLL supply voltage is specified at input of the filter and not at pin of the MSC8156 (see Figure 37 and Figure 38)

Table 1. Signal List by Ball Number (continued)

Ball Number	Signal Name[1,2]	Pin Type[10]	Power Rail Name
AH17	$\overline{\text{M1DQS6}}$	I/O	GVDD1
AH18	M1DQS6	I/O	GVDD1
AH19	M1DQ48	I/O	GVDD1
AH20	M1DQ49	I/O	GVDD1
AH21	VSS	Ground	N/A
AH22	TDM0RCK/GE2_RD2[3]	I/O	NVDD
AH23	TDM0RDT/GE2_RD3[3]	I/O	NVDD
AH24	TDM0TSN/GE2_RD0[3]	I/O	NVDD
AH25	TDM1RCK/GE2_RD1[3]	I/O	NVDD
AH26	TDM3TDT/GE1_RD3[3]	I/O	NVDD
AH27	TDM3TCK/GE1_RD2[3]	I	NVDD
AH28	VSS	Ground	N/A

Notes:
1. Reserved signals should be disconnected for compatibility with future revisions of the device. Non-user signals are reserved for manufacturing and test purposes only. The assigned signal name is used to indicate whether the signal must be unconnected (Reserved), pulled down (VSS), or pulled up (VDD).
2. Signal function during power-on reset is determined by the RCW source type.
3. Selection of TDM versus RGMII functionality is determined by the RCW bit values.
4. Selection of RapidIO, SGMII, and PCI Express functionality is determined by the RCW bit values.
5. Selection of the GPIO function and other functions is done by GPIO register setup. For configuration details, see the *GPIO* chapter in the *MSC8156 Reference Manual*.
6. Open-drain signal.
7. Internal 20 KΩ pull-up resistor.
8. For signals with GPIO functionality, the open-drain and internal 20 KΩ pull-up resistor can be configured by GPIO register programming. See the *GPIO* chapter of the *MSC8156 Reference Manual* for configuration details.
9. Connect to power supply via external filter. See **Section 3.2**, *PLL Power Supply Design Considerations* for details.
10. Pin types are: Ground = all VSS connections; Power = all VDD connections; I = Input; O = Output; I/O = Input/Output; NC = not connected.

Table 1. Signal List by Ball Number (continued)

Ball Number	Signal Name[1,2]	Pin Type[10]	Power Rail Name
AF27	TDM2TDT/GE1_TX_CLK[3]	I/O	NVDD
AF28	TDM3RSN/GE1_RD1[3]	I/O	NVDD
AG1	M1DQ24	I/O	GVDD1
AG2	GVDD1	Power	N/A
AG3	M1DQ25	I/O	GVDD1
AG4	VSS	Ground	N/A
AG5	GVDD1	Power	N/A
AG6	M1ECC1	I/O	GVDD1
AG7	VSS	Ground	N/A
AG8	GVDD1	Power	N/A
AG9	M1A13	O	GVDD1
AG10	VSS	Ground	N/A
AG11	GVDD1	Power	N/A
AG12	$\overline{\text{M1CS1}}$	O	GVDD1
AG13	VSS	Ground	N/A
AG14	GVDD1	Power	N/A
AG15	M1DQ35	I/O	GVDD1
AG16	VSS	Ground	N/A
AG17	GVDD1	Power	N/A
AG18	M1DQ51	I/O	GVDD1
AG19	VSS	Ground	N/A
AG20	GVDD1	Power	N/A
AG21	NVDD	Power	N/A
AG22	TDM1TSN/GE2_TD1[3]	I/O	NVDD
AG23	TDM1RDT/GE2_TX_CLK[3]	I/O	NVDD
AG24	TDM0TCK/GE2_GTX_CLK[3]	I/O	NVDD
AG25	TDM1TDT/GE2_TD0[3]	I/O	NVDD
AG26	VSS	Ground	N/A
AG27	NVDD	Power	N/A
AG28	TDM3RDT/GE1_RD0[3]	I/O	NVDD
AH1	Reserved.	NC	—
AH2	$\overline{\text{M1DQS3}}$	I/O	GVDD1
AH3	M1DQS3	I/O	GVDD1
AH4	M1ECC0	I/O	GVDD1
AH5	$\overline{\text{M1DQS8}}$	I/O	GVDD1
AH6	M1DQS8	I/O	GVDD1
AH7	M1A5	O	GVDD1
AH8	$\overline{\text{M1CK1}}$	O	GVDD1
AH9	M1CK1	O	GVDD1
AH10	$\overline{\text{M1CS0}}$	O	GVDD1
AH11	M1BA0	O	GVDD1
AH12	$\overline{\text{M1CAS}}$	O	GVDD1
AH13	M1DQ34	I/O	GVDD1
AH14	$\overline{\text{M1DQS4}}$	I/O	GVDD1
AH15	M1DQS4	I/O	GVDD1
AH16	M1DQ50	I/O	GVDD1